


Small Outline Optoisolators Transistor Output (Low Input Current)

These devices consist of a gallium arsenide infrared emitting diode optically coupled to a monolithic silicon phototransistor detector, in a surface mountable, small outline, plastic package. They are ideally suited for high density applications, and eliminate the need for through-the-board mounting.

- Convenient Plastic SOIC-8 Surface Mountable Package Style
- Low LED Input Current Required, for Easier Logic Interfacing
- Standard SOIC-8 Footprint, with 0.050" Lead Spacing
- Compatible with Dual Wave, Vapor Phase and IR Reflow Soldering
- High Input-Output Isolation of 3000 Vac (rms) Guaranteed
- UL Recognized  File #E90700, Volume 2

Ordering Information:

- To obtain MOC215, 216, 217 in Tape and Reel, add R2 suffix to device numbers:
R2 = 2500 units on 13" reel
- To obtain MOC215, 216, 217 in quantities of 50 (shipped in sleeves) — No Suffix

Marking Information:

- MOC215 = 215
- MOC216 = 216
- MOC217 = 217

Applications:

- Low power Logic Circuits
- Interfacing and coupling systems of different potentials and impedances
- Telecommunications equipment
- Portable electronics

MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
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INPUT LED

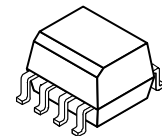
Forward Current — Continuous	I_F	60	mA
Forward Current — Peak (PW = 100 μs , 120 pps)	$I_F(\text{pk})$	1.0	A
Reverse Voltage	V_R	6.0	V
LED Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	90 0.8	mW mW/ $^\circ\text{C}$

OUTPUT TRANSISTOR

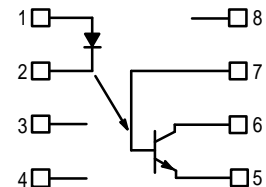
Collector-Emitter Voltage	V_{CEO}	30	V
Collector-Base Voltage	V_{CB0}	70	V
Emitter-Collector Voltage	V_{ECO}	7.0	V
Collector Current — Continuous	I_C	150	mA
Detector Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	150 1.76	mW mW/ $^\circ\text{C}$

MOC215
MOC216
MOC217

**SMALL OUTLINE
OPTOISOLATORS
TRANSISTOR OUTPUT**



SCHEMATIC



1. LED ANODE
2. LED CATHODE
3. NO CONNECTION
4. NO CONNECTION
5. EMITTER
6. COLLECTOR
7. BASE
8. NO CONNECTION

MAXIMUM RATINGS — continued ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Rating	Symbol	Value	Unit
TOTAL DEVICE			
Input–Output Isolation Voltage ^(1,2) (60 Hz, 1.0 sec. duration)	V_{ISO}	3000	Vac(rms)
Total Device Power Dissipation @ $T_A = 25^\circ\text{C}$ Derate above 25°C	P_D	250 2.94	mW mW/ $^\circ\text{C}$
Ambient Operating Temperature Range ⁽³⁾	T_A	–45 to +100	$^\circ\text{C}$
Storage Temperature Range ⁽³⁾	T_{stg}	–45 to +125	$^\circ\text{C}$
Lead Soldering Temperature (1/16" from case, 10 sec. duration)	—	260	$^\circ\text{C}$

ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)⁽⁴⁾

Characteristic	Symbol	Min	Typ ⁽⁴⁾	Max	Unit
INPUT LED					
Forward Voltage ($I_F = 1.0\text{ mA}$)	V_F	—	1.05	1.3	V
Reverse Leakage Current ($V_R = 6.0\text{ V}$)	I_R	—	0.1	100	μA
Capacitance	C	—	18	—	pF

OUTPUT TRANSISTOR

Collector–Emitter Dark Current ($V_{CE} = 5.0\text{ V}$, $T_A = 25^\circ\text{C}$) ($V_{CE} = 5.0\text{ V}$, $T_A = 100^\circ\text{C}$)	I_{CEO1}	—	1.0	50	nA
	I_{CEO2}	—	1.0	—	μA
Collector–Emitter Breakdown Voltage ($I_C = 100\ \mu\text{A}$)	$V_{(BR)CEO}$	30	90	—	V
Emitter–Collector Breakdown Voltage ($I_E = 100\ \mu\text{A}$)	$V_{(BR)ECO}$	7.0	7.8	—	V
Collector–Emitter Capacitance ($f = 1.0\text{ MHz}$, $V_{CE} = 0$)	C_{CE}	—	7.0	—	pF

COUPLED

Output Collector Current ($I_F = 1.0\text{ mA}$, $V_{CE} = 5.0\text{ V}$)	MOC215 MOC216 MOC217	I_C (CTR) ⁽⁵⁾	200 (20) 500 (50) 1.0 (100)	500(50) 800 (80) 1.3 (130)	— — —	μA (%) μA (%) mA (%)
Collector–Emitter Saturation Voltage ($I_C = 100\ \mu\text{A}$, $I_F = 1.0\text{ mA}$)		$V_{CE(sat)}$	—	0.35	0.4	V
Turn–On Time ($I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$)		t_{on}	—	7.5	—	μs
Turn–Off Time ($I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$)		t_{off}	—	5.7	—	μs
Rise Time ($I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$)		t_r	—	3.2	—	μs
Fall Time ($I_C = 2.0\text{ mA}$, $V_{CC} = 10\text{ V}$, $R_L = 100\ \Omega$)		t_f	—	4.7	—	μs
Input–Output Isolation Voltage ($f = 60\text{ Hz}$, $t = 1.0\text{ sec.}$) ^(1,2)		V_{ISO}	3000	—	—	Vac(rms)
Isolation Resistance ($V_{I-O} = 500\text{ V}$) ⁽²⁾		R_{ISO}	10^{11}	—	—	Ω
Isolation Capacitance ($V_{I-O} = 0$, $f = 1.0\text{ MHz}$) ⁽²⁾		C_{ISO}	—	0.2	—	pF

1. Input–Output Isolation Voltage, V_{ISO} , is an internal device dielectric breakdown rating.
2. For this test, pins 1 and 2 are common, and pins 5, 6 and 7 are common.
3. Refer to Quality and Reliability Section in Opto Data Book for information on test conditions.
4. Always design to the specified minimum/maximum electrical limits (where applicable).
5. Current Transfer Ratio (CTR) = $I_C/I_F \times 100\%$.

TYPICAL CHARACTERISTICS

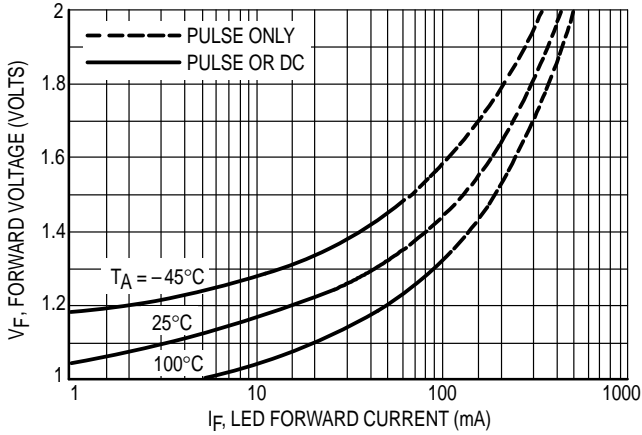


Figure 1. LED Forward Voltage versus Forward Current

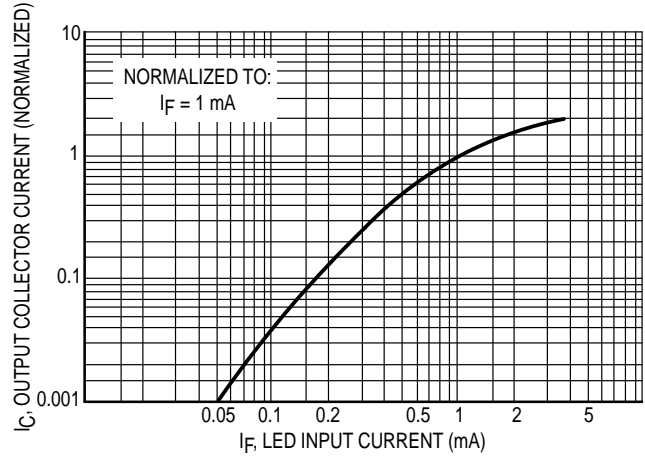


Figure 2. Output Current versus Input Current

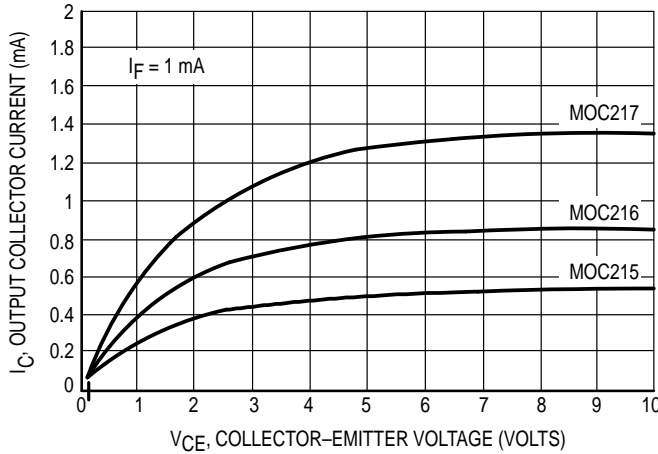


Figure 3. Output Current versus Collector-Emitter Voltage

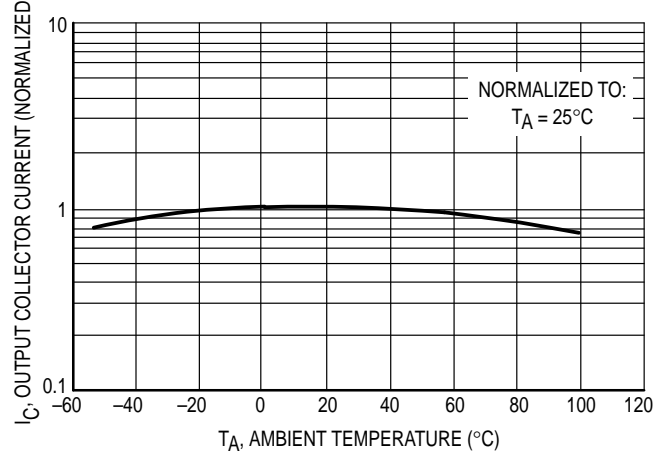


Figure 4. Output Current versus Ambient Temperature

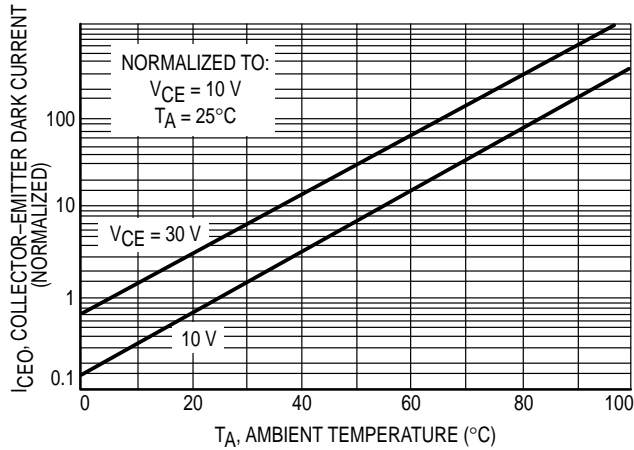


Figure 5. Dark Current versus Ambient Temperature

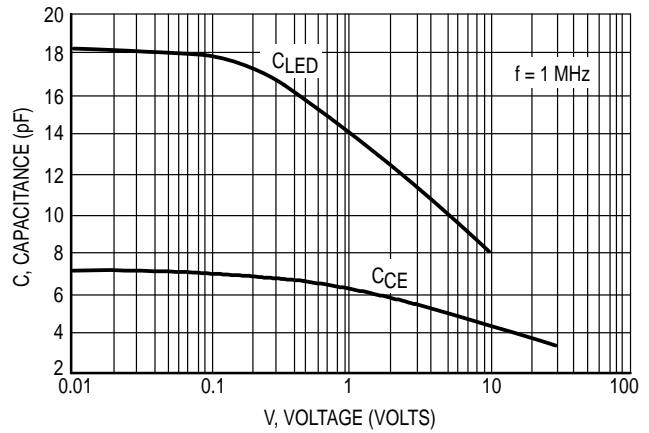
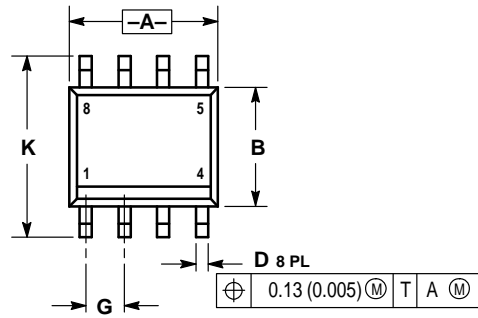


Figure 6. Capacitance versus Voltage

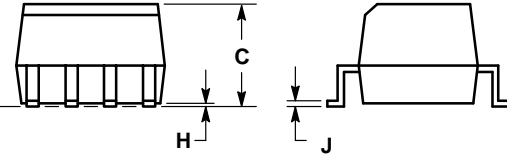
PACKAGE DIMENSIONS



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.182	0.202	4.63	5.13
B	0.144	0.164	3.66	4.16
C	0.123	0.143	3.13	3.63
D	0.011	0.021	0.28	0.53
G	0.050 BSC		1.27 BSC	
H	0.003	0.008	0.08	0.20
J	0.006	0.010	0.16	0.25
K	0.224	0.244	5.69	6.19

-T- SEATING PLANE
0.038 (0.0015)



- STYLE 1:
PIN 1. ANODE
2. CATHODE
3. NC
4. NC
5. EMITTER
6. COLLECTOR
7. BASE
8. NC

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MOC215-M

SO8 Phototransistor Coupler

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General description

These devices consist of a gallium arsenide infrared emitting diode optically coupled to a monolithic silicon phototransistor detector, in a surface mountable, small outline, plastic package. They are ideally suited for high density applications and eliminate the need for through-the-board mounting.

- Convenient plastic SOIC-8 surface mountable package style
- Low LED input current required, for easier logic interfacing
- Standard SOIC-8 footprint, with a 0.050-inch lead spacing
- Compatible with dual wave, vapor phase and IR reflow soldering
- High input - Output isolation of 3000 VAC (RMS) guaranteed
- Underwriters Laboratory (UL) recognized - File #E90700, Volume 2

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Applications

- Low power logic circuits
- Interfacing and coupling systems of different potentials and impedances
- Telecommunications equipment
- Portable electronics

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Ordering information

The following options can be ordered with this part:

Option	Order Entry Identifier	Description
R1	R1	Surface-Mount Lead Bend Tape and Reel (500-pc reel)
R2	R2	Surface-Mount Lead Bend Tape and Reel (2500-pc reel)

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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Packing method
MOC215-M	Full Production	\$0.264	SOIC	8	RAIL
MOC215R1-M	Full Production	\$0.273	SOIC	8	TAPE REEL
MOC215R2-M	Full Production	\$0.273	SOIC	8	TAPE REEL

* 1,000 piece Budgetary Pricing

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Safety agency certificates

Certificate	Agency	
8460,8461 (171 K)	BSI	British Standards Institution
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MOC216-M

SO8 Phototransistor Coupler

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R1	R1	Surface-Mount Lead Bend Tape and Reel (500-pc reel)
R2	R2	Surface-Mount Lead Bend Tape and Reel (2500-pc reel)

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Product status/pricing/packaging

Product	Product status	Pricing*	Package type	Leads	Packing method
MOC216-M	Full Production	\$0.281	SOIC	8	RAIL
MOC216R1-M	Full Production	\$0.291	SOIC	8	TAPE REEL
MOC216R2-M	Full Production	\$0.291	SOIC	8	TAPE REEL

* 1,000 piece Budgetary Pricing

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MOC217-M

SO8 Phototransistor Coupler

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MOC217R1-M	Full Production	\$0.291	SOIC	8	TAPE REEL
MOC217R2-M	Full Production	\$0.291	SOIC	8	TAPE REEL

* 1,000 piece Budgetary Pricing

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4N32-M replaced by 4N32	4N33-M replaced by 4N33	4N35-M
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H11AV1A-M	H11AV2-M	H11AV2A-M
H11B1-M replaced by H11B1	H11B3-M replaced by H11B3	H11D1-M replaced by H11D1
H11D2-M replaced by H11D2	H11G1-M replaced by H11G1	H11G2-M replaced by H11G2
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H11L3-M		

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MOC213-M	MOC215-M	MOC216-M
MOC217-M	MOC223-M	MOC256-M
MOC3010-M	MOC3011-M	MOC3012-M
MOC3020-M	MOC3021-M	MOC3022-M
MOC3023-M	MOC3031-M	MOC3032-M
MOC3033-M	MOC3041-M	MOC3042-M
MOC3043-M	MOC3051-M	MOC3052-M
MOC3061-M	MOC3062-M	MOC3063-M
MOC3081-M	MOC3081-M	MOC3083-M
MOC3162-M	MOC3163-M	MOC5007-M
MOC5008-M	MOC5009-M	MOC8030-M replaced by MOC8030

MOC8050-M replaced by MOC8050	MOC8080-M replaced by MOC8080	MOC8100-M
MOC8204-M replaced by MOC8204	MOCD207-M	MOCD208-M
MOCD211-M	MOCD213-M	MOCD217-M
MOCD223-M		

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